MOSFET – Power, N-Channel, SUPERFET[®] III, FRFET[®]

650 V, 65 A, 40 m Ω

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

Features

- 700 V @ $T_J = 150^{\circ}C$
- Typ. R_{DS(on)} = 33.8 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 153 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 1333 pF)
- 100% Avalanche Tested
- AEC-Q101 Qualified and PPAP Capable

Applications

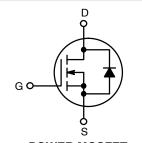
- Automotive On Board Charger HEV-EV
- Automotive DC/DC converter for HEV-EV



ON Semiconductor®

www.onsemi.com

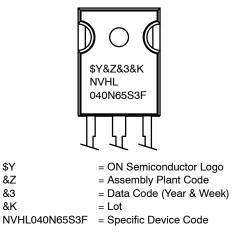
| V _{DSS} | R _{DS(ON)} MAX | I _D MAX |
|------------------|-------------------------|--------------------|
| 650 V | 40 m Ω @ 10 V | 65 A |



POWER MOSFET



MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

| Symbol | Paramete | NVHL040N65S3F | Unit V | |
|-----------------------------------|---|---------------------------------------|-------------|------|
| V _{DSS} | Drain to Source Voltage | | | 650 |
| V _{GSS} | Gate to Source Voltage | – DC | ±30 | V |
| | | – AC (f > 1 Hz) | ±30 | |
| I _D Drain Current | Drain Current | – Continuous (T _C = 25°C) | 65 | А |
| | | – Continuous (T _C = 100°C) | 45 | |
| I _{DM} | Drain Current | – Pulsed (Note 1) | 162.5 | А |
| E _{AS} | Single Pulsed Avalanche Energy (Note 2) | | 1009 | mJ |
| E _{AR} | Repetitive Avalanche Energy (Note 1) | | 4.46 | mJ |
| dv/dt | MOSFET dv/dt | | 100 | V/ns |
| | Peak Diode Recovery dv/dt (Note 3) | | 50 | |
| PD | Power Dissipation | (T _C = 25°C) | 446 | W |
| | | - Derate Above 25°C | 3.57 | W/∘C |
| T _J , T _{STG} | Operating and Storage Temperature Range | | –55 to +150 | °C |
| ΤL | Maximum Lead Temperature for Soldering, | 300 | °C | |

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 9 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}C$. 3. $I_{SD} \leq 32.5 \text{ A}$, di/dt $\leq 200 \text{ A}/\mu\text{s}$, $V_{DD} \leq 400 \text{ V}$, starting $T_J = 25^{\circ}C$.

THERMAL CHARACTERISTICS

| Symbol | Parameter | NVHL040N65S3F | Unit |
|---------------------|---|---------------|------|
| $R_{	ext{	heta}JC}$ | Thermal Resistance, Junction to Case, Max. | 0.28 | °C/W |
| R _{0JA} | Thermal Resistance, Junction to Ambient, Max. | 40 | |

PACKAGE MARKING AND ORDERING INFORMATION

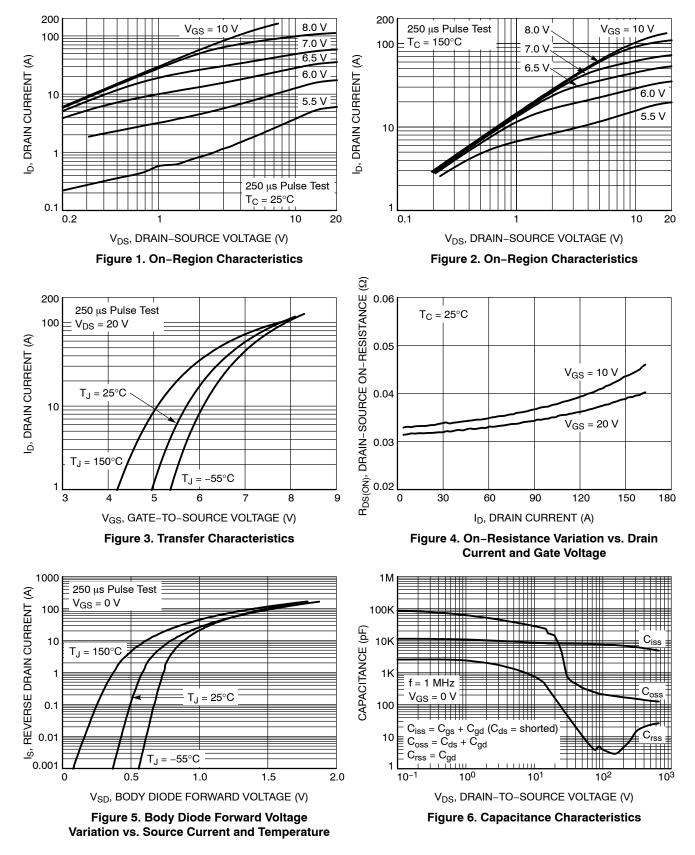
| Part Number | Top Marking | Package | Packing Method | Reel Size | Tape Width | Quantity |
|---------------|---------------|---------|----------------|-----------|------------|----------|
| NVHL040N65S3F | NVHL040N65S3F | TO-247 | Tube | N/A | N/A | 30 Units |

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

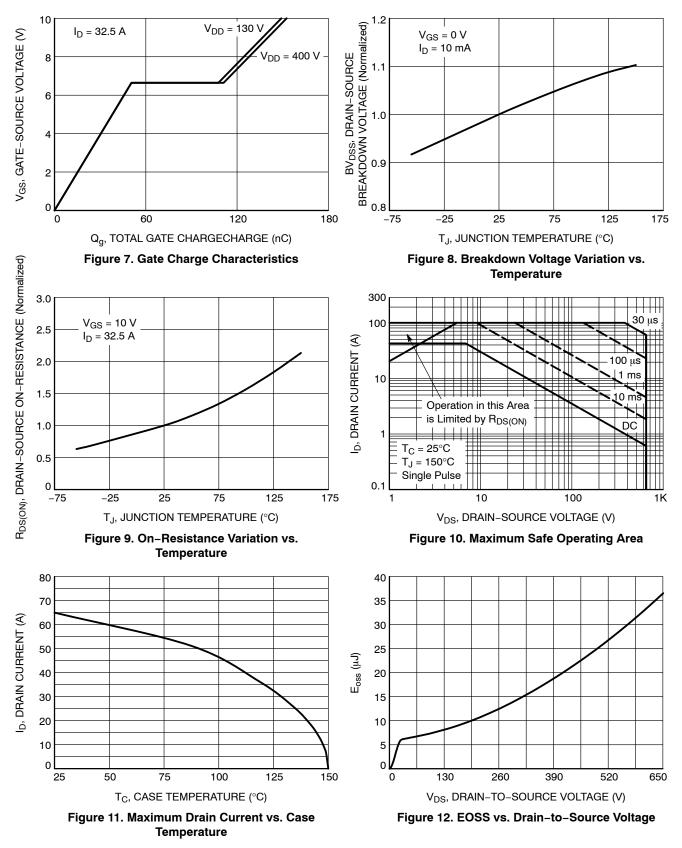
| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|--|--|---|------|------|-------|------|
| OFF CHARACT | ERISTICS | · | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C | 650 | - | - | V |
| | | V_{GS} = 0 V, I_{D} = 10 mA, T_{J} = 150°C | 700 | - | - | V |
| $\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$ | Breakdown Voltage Temperature Coefficient | $I_D = 10$ mA, Referenced to $25^{\circ}C$ | _ | 0.64 | - | V/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$ | - | - | 10 | μA |
| | | V_{DS} = 520 V, T_{C} = 125°C | - | 103 | - | |
| I _{GSS} | Gate to Body Leakage Current | V_{GS} = ±30 V, V_{DS} = 0 V | - | - | ±100 | nA |
| ON CHARACTE | RISTICS | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{GS} = V_{DS}, I_D = 2.1 \text{ mA}$ | 3.0 | - | 5.0 | V |
| R _{DS(on)} | Static Drain to Source On Resistance | V _{GS} = 10 V, I _D = 32.5 A | - | 33.8 | 40 | mΩ |
| 9fs | Forward Transconductance | V _{DS} = 20 V, I _D = 32.5 A | - | 40 | - | S |
| OYNAMIC CHAI | RACTERISTICS | · | | | | |
| C _{iss} | Input Capacitance | V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz | - | 5875 | - | pF |
| Coss | Output Capacitance | | - | 140 | - | pF |
| C _{oss(eff.)} | Effective Output Capacitance | V_{DS} = 0 V to 400 V, V_{GS} = 0 V | - | 1333 | - | pF |
| C _{oss(er.)} | Energy Related Output Capacitance | V_{DS} = 0 V to 400 V, V_{GS} = 0 V | - | 241 | - | pF |
| Q _{g(tot)} | Total Gate Charge at 10 V | $V_{DS} = 400 \text{ V}, \text{ I}_{D} = 32.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$ | - | 153 | - | nC |
| Q _{gs} | Gate to Source Gate Charge | (Note 4) | - | 51 | - | nC |
| Q _{gd} | Gate to Drain "Miller" Charge | | - | 61 | - | nC |
| ESR | Equivalent Series Resistance | f = 1 MHz | - | 1.9 | - | Ω |
| WITCHING CH | IARACTERISTICS | | | | | - |
| t _{d(on)} | Turn-On Delay Time | $V_{DD} = 400 \text{ V}, \text{ I}_{D} = 32.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$ | - | 41 | - | ns |
| t _r | Turn-On Rise Time | R _g = 2.2 Ω (Note 4) | - | 53 | - | ns |
| t _{d(off)} | Turn-Off Delay Time | | - | 96 | - | ns |
| t _f | Turn-Off Fall Time | | - | 28 | - | ns |
| SOURCE-DRAII | N DIODE CHARACTERISTICS | · | | | | |
| ۱ _S | Maximum Continuous Source to Drain Diode Forward Current | | | - | 65 | А |
| I _{SM} | Maximum Pulsed Source to Drain Diode | Forward Current | - | - | 162.5 | А |
| V _{SD} | Source to Drain Diode Forward Voltage | $V_{GS} = 0 V, I_{SD} = 32.5 A$ | - | - | 1.3 | V |
| t _{rr} | Reverse Recovery Time | $V_{GS} = 0 V, I_{SD} = 32.5 A,$ | - | 159 | - | ns |
| Q _{rr} | Reverse Recovery Charge | dI _F /dt = 100 A/μs | _ | 840 | _ | nC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

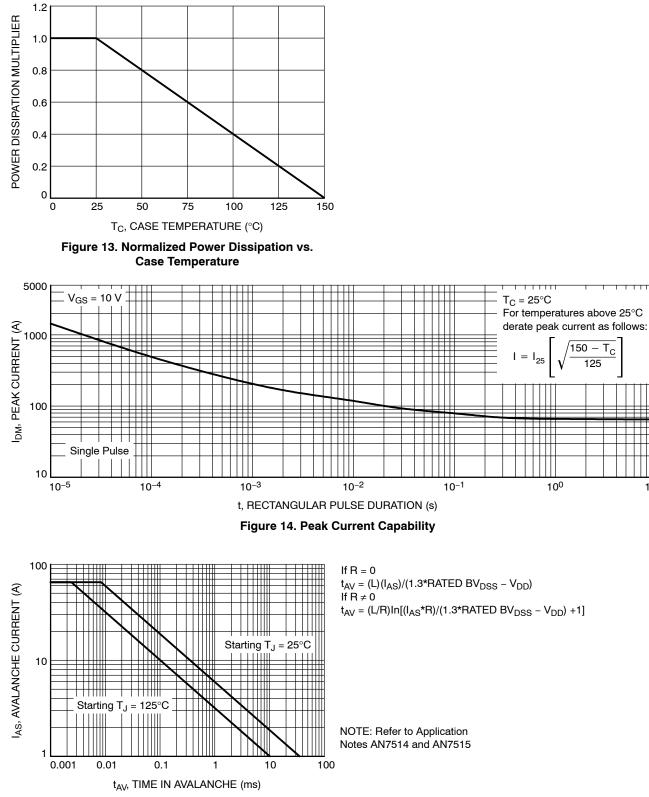
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



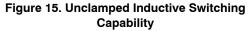
TYPICAL CHARACTERISTICS



150 – T_C

125

10¹



www.onsemi.com 6

TYPICAL CHARACTERISTICS

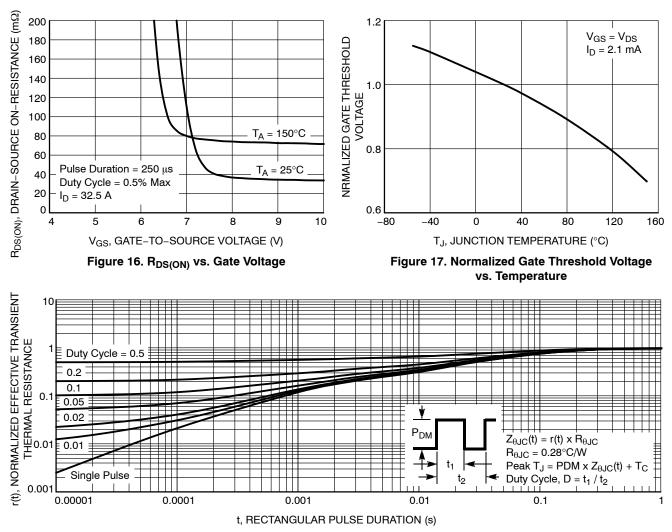
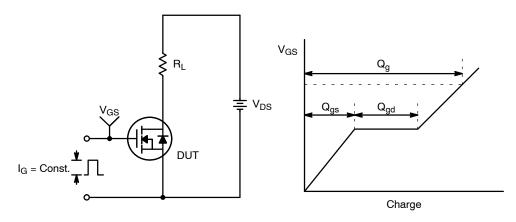


Figure 18. Transient Thermal Response Curve





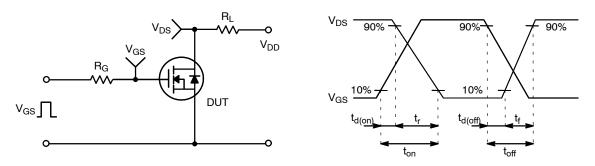
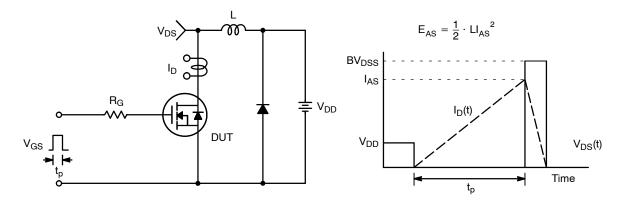


Figure 20. Resistive Switching Test Circuit & Waveforms





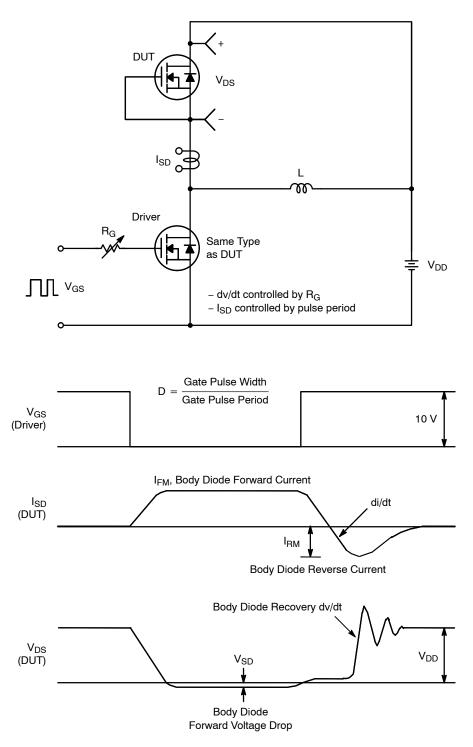
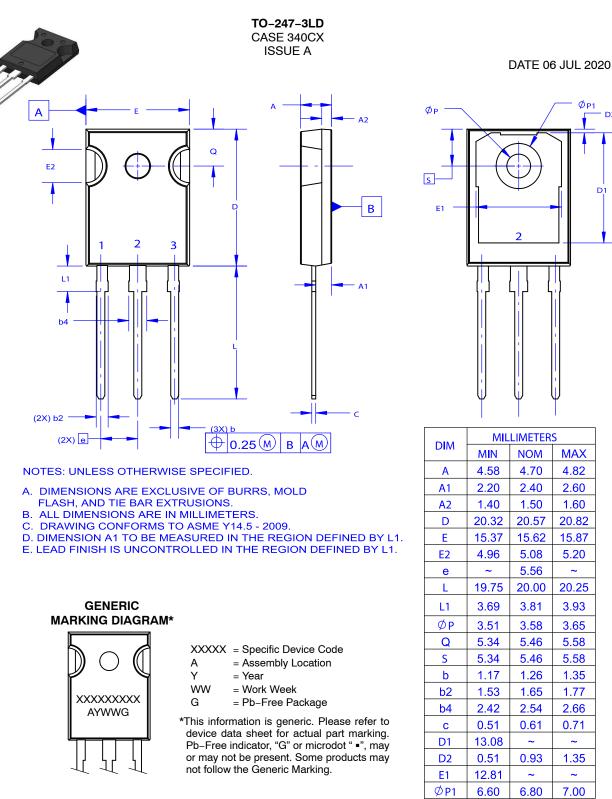


Figure 22. Peak Diode Recovery dv/dt Test Circuit & Waveforms

SUPERFET and FRFET are a registered trademarks of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.



| DOCUMENT NUMBER: | 98AON93302G | Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | | | |
|------------------|-------------|---|-------------|--|--|
| DESCRIPTION: | TO-247-3LD | | PAGE 1 OF 1 | | |

ON Semiconductor and 💷 are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

D2

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

 \Diamond